



Product data sheet

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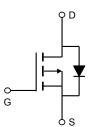
AO4409-MS HF Compiance







- VDS (V) =-30V
- ID =-15 A (VGS =-10V)
- $R_{DS(ON)} < 7.5 m \Omega$ (Vgs =-10V)
- $RDS(ON) < 12m \Omega$ (VGS =-4.5V)



Absolute Maximum Ratings Ta = 25°C

Parameter	Symbol	Rating	Unit		
Drain-Source Voltage		Vds	-30	v	
Gate-Source Voltage		Vgs	±20	v	
Continuous Drain Current	Ta=25°C	D	-15		
	Ta=70°C		-12.8	•	
Pulsed Drain Current	ldм	-80	A		
Avalanche Current		las,lar	30		
Avalanche energy	L=0.1mH	Eas,Ear	135	mJ	
Power Dissipation	Ta=25°C	PD	3.1	w	
	TA=70°C		2	vv	
Thermal Resistance.Junction- to-Ambient	$t \le 10s$	RthJA	40		
	Steady-State		75	°C/W	
Thermal Resistance.Junction- to-Lead	RthJL	24			
Junction Temperature		TJ	150	ĉ	
Junction Storage Temperature Range	Tstg	-55 to 150	C		



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Electrical Characteristics Ta = 25° C

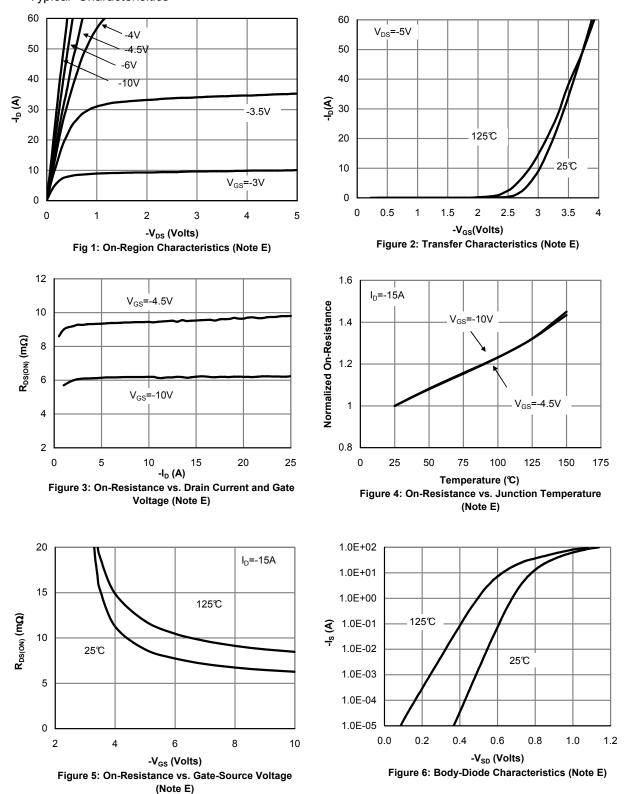
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit	
Drain-Source Breakdown Voltage	VDSS	ID=-250 µ A, VGS=0V	-30			V	
	1	VDS=-30V, VGS=0V			-5	uA	
Zero Gate Voltage Drain Current	IDSS	VDs=-30V, VGs=0V, TJ=55℃			-25		
Gate-Body leakage current	IGSS	VDS=0V, VGS=±20V			± 100	nA	
Gate Threshold Voltage	VGS(th)	VDS=VGS ID=-250 µ A	-1.4		-2.7	V	
Static Drain-Source On-Resistance	RDS(ON)	Vgs=-10V, Id=-15A			7.5	<i>'</i> .5	
		Vgs=-10V, Ib=-15A TJ=125℃			11.5	m Ω	
		Vgs=-4.5V, Id=-10A			12		
On state drain current	ID(ON)	Vgs=-10V, Vds=-5V	-80			А	
Forward Transconductance	gfs	VDS=-5V, ID=-15A	35	50		S	
Input Capacitance	Ciss			5270	6400	pF	
Output Capacitance	Coss	Vgs=0V, Vbs=-15V, f=1MHz		945			
Reverse Transfer Capacitance	Crss			745			
Gate resistance	Rg	Vgs=0V, Vds=0V, f=1MHz		2	3	Ω	
Total Gate Charge (10V)	Qg			100	120	nC	
Total Gate Charge (4.5V)	Qg	Vgs=-10V, Vds=-15V, Id=-15A		51.5			
Gate Source Charge	Qgs	VGS10V, VDS15V, ID15A		14.5			
Gate Drain Charge	Qgd			23			
Turn-On DelayTime	td(on)			14		ns	
Turn-On Rise Time	tr	Vgs=-10V, Vbs=-15V, RL=1Ω,		16.5			
Turn-Off DelayTime	td(off)	Rgen=3Ω		76.5			
Turn-Off Fall Time	tr			37.5			
Body Diode Reverse Recovery Time	trr			36.7	45		
Body Diode Reverse Recovery Charge	Qrr	I⊧=-15A, dı/dt=100A/us		28		nC	
Maximum Body-Diode Continuous Current	ls				-5	А	
Diode Forward Voltage	Vsd	Is=-1A,VGs=0V			-1	V	

Note : The static characteristics in Figures 1 to 6 are obtained using <300 μs pulses, duty cycle 0.5% max.



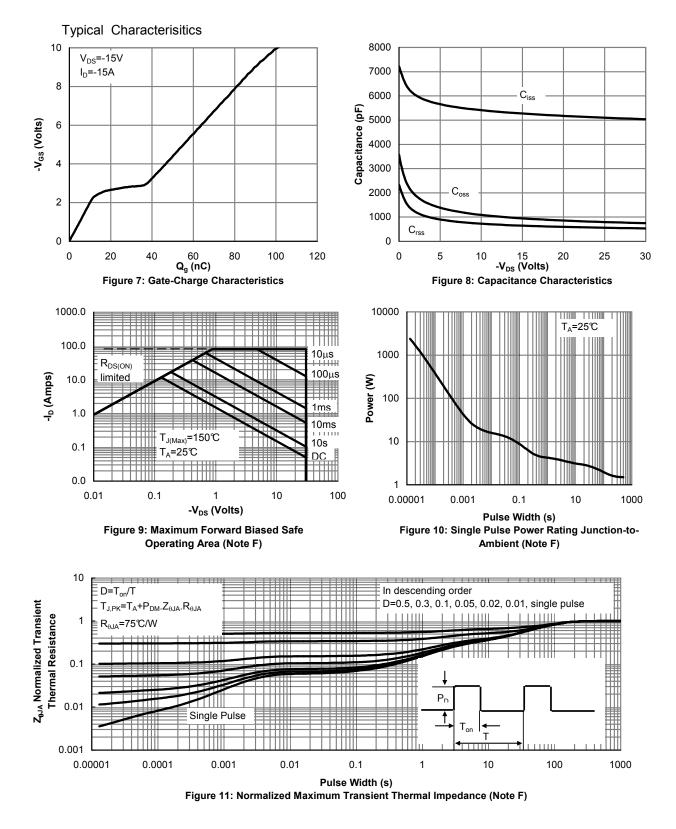


Typical Characterisitics





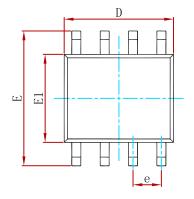
AO4409-MS Semiconductor

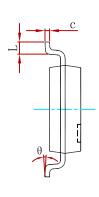


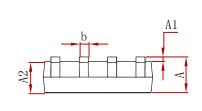


AO4409-MS HF RoHS Semiconductor Compiance

PACKAGE MECHANICAL DATA

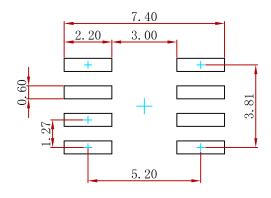






Symbol	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min	Max	Min	Max	
А	1.350	1.750	0.053	0.069	
A1	0.100	0.250	0.004	0.010	
A2	1.350	1.550	0.053	0.061	
b	0.330	0.510	0.013	0.020	
с	0.170	0.250	0.007	0.010	
D	4.800	5.000	0.189	0.197	
e	1.270 (BSC)		0.050 (BSC)		
E	5.800	6.200	0.228	0.244	
E1	3.800	4.000	0.150	0.157	
L	0.400	1.270	0.016	0.050	
θ	0 °	8°	0 °	8°	

Suggested Pad Layout



Note:

Controlling dimension:in millimeters.
General tolerance:± 0.05mm.
The pad layout is for reference purposes only.

REEL SPECIFICATION

P/N	PKG	QTY
AO4409-MS	SOP-8	3000





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